

SDxxC Series

Low capacitance bidirectional TVS Diodes for ESD Protection

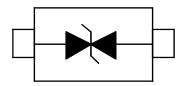
SDxxC Series is high performance capacitance bidirectional TVS Diodes designed for applications requiring transient overvoltage protection capability. They are intended for use in voltage and ESD sensitive equipment such as computers, printers, business machines, communication systems, medical equipment and other applications. These devices are ideal for situations where board space is at a premium.

Features

- Peak Power Dissipation 300 W (8 x 20 us Waveform)
- Replacement for MLV (0805)
- Protects One Power or I/O Port
- Low Clamping Voltage
- Low Leakage
- Response Time is < 1 ns
- Available in Multiple Voltages Ranging From 3V to36V
- Meets MSL 1 Requirements
- Solid-state silicon avalanche technology
- ROHS compliant



SOD-323



Main applications

- Cellular handsets AND accessories
- Portable instrumentation
- Peripherals
- Networking and Telecom
- Serial and Parallel Ports
- Notebooks, Desktops, Servers
- Projection TV

Protection solution to meet

- IEC61000-4-2 (ESD) ±15kV (air), ±10kV (contact)
- IEC61000-4-4 (EFT) 40A (5/50ns)

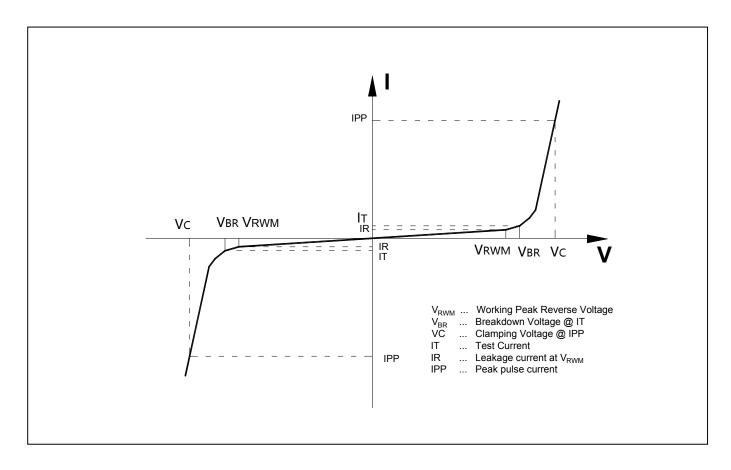


Maximum ratings (Tamb=25℃ Unless Otherwise Specified)

Rating	Symbol	Value	Unit
Peak Pulse Power (tp=8/20µs waveform)	P _{PK}	300	Watts
ESD Rating per IEC61000-4-2 (Contact) ESD Rating per IEC61000-4-2 (Air)	V _{ESD}	10 15	KV
Lead Soldering Temperature	TL	260 (10 sec.)	$^{\circ}$
Operating Temperature Range	TJ	-55 ~ 150	$^{\circ}$
Storage Temperature Range	TSTG	-55 ~ 150	$^{\circ}$

Attention: Stresses above the max. values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit.

Electrical Characteristics at TA = 25 °C, unless otherwise specified







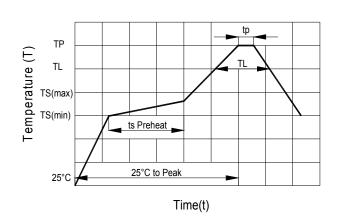
Electrical characteristics (Tamb=25℃ Unless Otherwise Specified)

DEVICE	VRWM	IR @VRWM	VBR @ 1mA	VC@ 1A	IPP _{Max}	C@0V,1MHz	PPK
	(V)	(uA)	(V)	(V)	(A)	PF(TYP.)	(W)
SD03C	3.3	20	4.0	7.8	25	120	300
SD05C	5	5	6.3	9.8	25	135	300
SD08C	8	1	9.1	13.4	15	75	300
SD12C	12	1	13.3	19	12	45	300
SD15C	15	1	16.7	24	12	45	300
SD24C	24	1	26.1	43	5	35	300
SD36C	36	1	40	60	3	35	300

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Soldering Parameters

Reflow co	ndition	LF assembly	
Pre heat	Temperature min (T _{s(min)})	150℃	
	Temperature Max(T _{s(Max)})	200℃	
	Time (Min To Max)(t _s)	60-180S	
Average ramp up rate		3℃/s max	
(liquidus temp(T _i)) to peak			
T _{s(max)} to T _L –ramp-up rate		3℃/s max	
Reflow	Temperature (T_L) (Liquidus)	217℃	
	Time(min to max)(t _s)	60-150S	
Peak temperature(T _P)		260℃	
Time within 5℃ of actual peak		20.400	
temperature		20-40s	
Ramp-down rate		6℃/s max	
Time 25℃ to peak temperature(t _p)		8minutes max	
Do not exceed		280℃	





Typical Characteristics at TA = 25 °C, unless otherwise specified

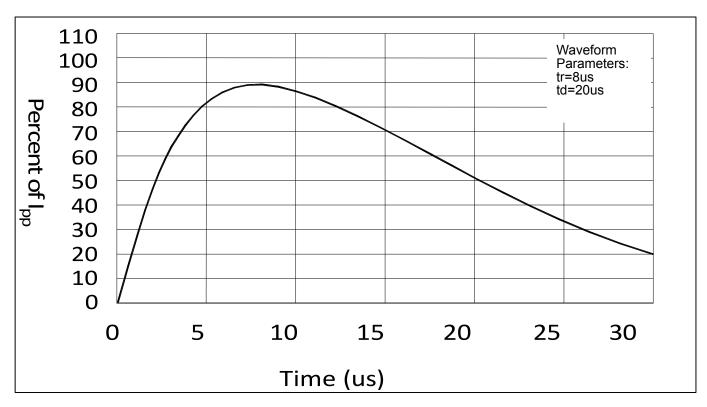


Figure 4-1 Pulse Waveform

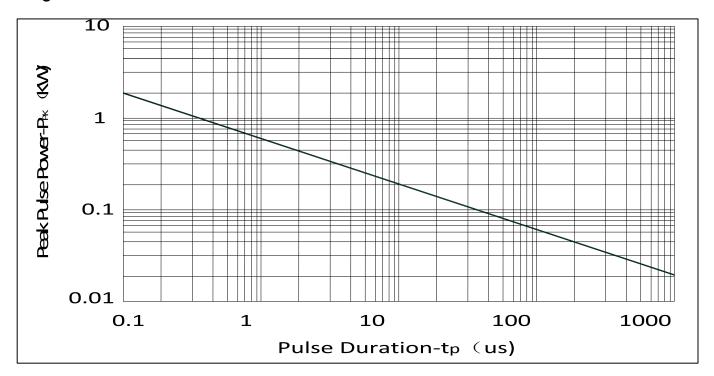


Figure 4-2 Non-Repetitive Peak Pulse Power vs. Pulse Time



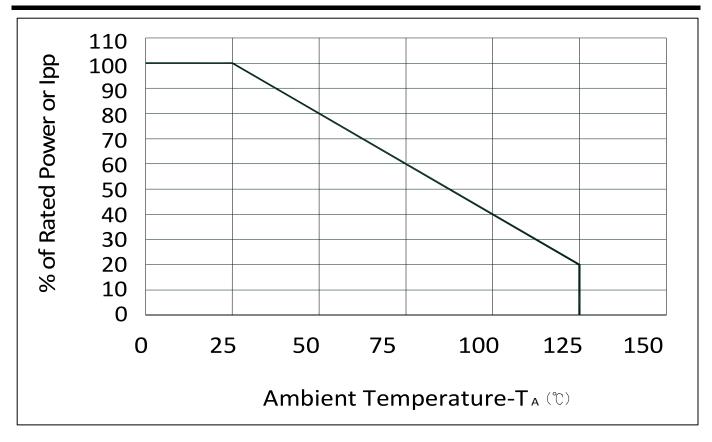


Figure 4-3 Power Derating Curve

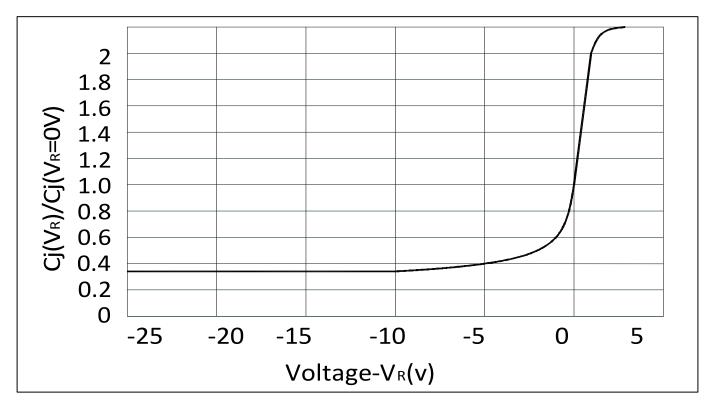
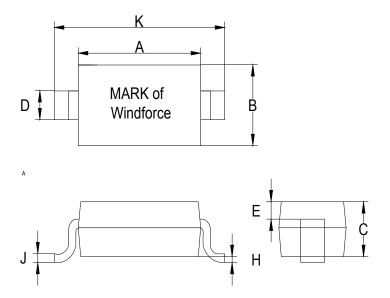


Figure 4-4 Junction Capacitance vs. Reverse Voltage



Mechanical Data

SOD-323

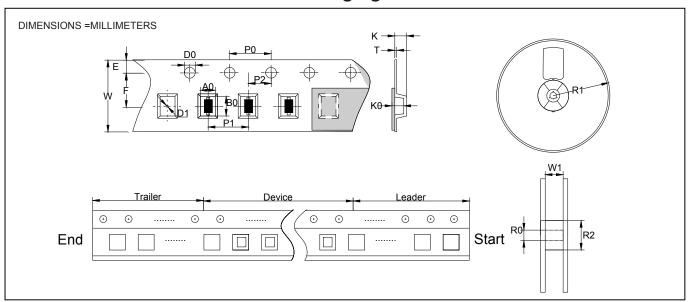


DIM	Millimeters		
DIM	Min	Max	
Α	1.60	1.80	
В	1.15	1.35	
С	0.80	1.00	
D	0.25	0.40	
E	0.15REF		
Н	0	0.10	
J	0.089	0.177	
K	2.30	2.70	

This is a molded SOD-323 package with lead free 100 % Sn plating on the lead frame. It has a flammability rating of UL 94V-0.



Packaging



The LEADER is a minimum of 20components in length and it consists of empty cavities with sealed cover tape The TRAILER is a minimum of 20 components in length and it consists of empty cavities with sealed cover tape

Item	Symbol	SOD-323
Carrier Width	A0	1.40±0.10
Carrier Length	В0	2.75±0.10
Carrier Depth	K0	1.15±0.10
Sprocket Hole	D0	1.50±0.05
Feed Hole Diameter	R0	13±0.20
Reel Outside Diameter	R1	178
Reel Inner Diameter	R2	50 MIN
Sprocket Hole Position	E	1.75±0.10
Punch Hole Position	F	3.50±0.05
Punch Hole Pitch	P1	4.00±0.10
Sprocket Hole Pitch	P0	4.00±0.10
Embossment Center	P2	2.00±0.05
Overall Tape Thickness	Т	0.20
Tape Width	W	8±0.20
Reel Width	W1	14.4 MAX
Quantity per Reel		3000





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